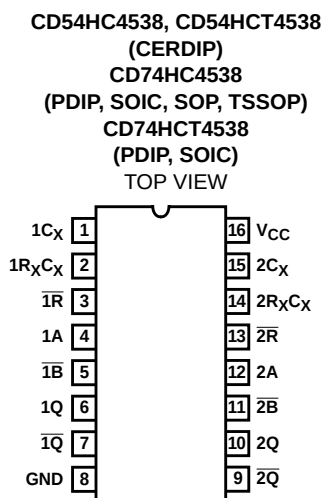


High-Speed CMOS Logic Dual Retriggerable Precision Monostable Multivibrator

Features

- Retriggerable/Resettable Capability
- Trigger and Reset Propagation Delays Independent of R_X , C_X
- Triggering from the Leading or Trailing Edge
- Q and $\bar{Q}$ Buffered Outputs Available
- Separate Resets
- Wide Range of Output Pulse Widths
- Schmitt Trigger Input on A and $\bar{B}$ Inputs
- Retrigger Time is Independent of C_X
- Fanout (Over Temperature Range)
 - Standard Outputs 10 LSTTL Loads
 - Bus Driver Outputs 15 LSTTL Loads
- Wide Operating Temperature Range . . . -55°C to 125°C
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
 - 2V to 6V Operation
 - High Noise Immunity: $N_{IL} = 30\%$, $N_{IH} = 30\%$ of V_{CC} at $V_{CC} = 5V$
- HCT Types
 - 4.5V to 5.5V Operation
 - Direct LSTTL Input Logic Compatibility, $V_{IL} = 0.8V$ (Max), $V_{IH} = 2V$ (Min)
 - CMOS Input Compatibility, $I_I \leq 1\mu A$ at V_{OL} , V_{OH}

Pinout



Description

The 'HC4538 and 'HCT4538 are dual retriggerable/resettable monostable precision multivibrators for fixed voltage timing applications. An external resistor (R_X) and an external capacitor (C_X) control the timing and the accuracy for the circuit. Adjustment of R_X and C_X provides a wide range of output pulse widths from the Q and $\bar{Q}$ terminals. The propagation delay from trigger input-to-output transition and the propagation delay from reset input-to-output transition are independent of R_X and C_X .

Leading-edge triggering (A) and trailing edge triggering ($\bar{B}$) inputs are provided for triggering from either edge of the input pulse. An unused "A" input should be tied to GND and an unused $\bar{B}$ should be tied to V_{CC} . On power up the IC is reset. Unused resets and sections must be terminated. In normal operation the circuit retriggers on the application of each new trigger pulse. To operate in the non-triggerable mode $\bar{Q}$ is connected to $\bar{B}$ when leading edge triggering (A) is used or Q is connected to A when trailing edge triggering ($\bar{B}$) is used. The period (τ) can be calculated from $\tau = (0.7) R_X C_X$; R_{MIN} is 5k Ω . C_{MIN} is 0pF.

Ordering Information

PART NUMBER	TEMP. RANGE (°C)	PACKAGE
CD54HC4538F3A	-55 to 125	16 Ld CERDIP
CD54HCT4538F3A	-55 to 125	16 Ld CERDIP
CD74HC4538E	-55 to 125	16 Ld PDIP
CD74HC4538M	-55 to 125	16 Ld SOIC
CD74HC4538MT	-55 to 125	16 Ld SOIC
CD74HC4538M96	-55 to 125	16 Ld SOIC
CD74HC4538NSR	-55 to 125	16 Ld SOP
CD74HC4538PW	-55 to 125	16 Ld TSSOP
CD74HC4538PWR	-55 to 125	16 Ld TSSOP
CD74HC4538PWT	-55 to 125	16 Ld TSSOP
CD74HCT4538E	-55 to 125	16 Ld PDIP
CD74HCT4538M	-55 to 125	16 Ld SOIC
CD74HCT4538MT	-55 to 125	16 Ld SOIC
CD74HCT4538M96	-55 to 125	16 Ld SOIC

NOTE: When ordering, use the entire part number. The suffixes 96 and R denote tape and reel. The suffix T denotes a small-quantity reel of 250.

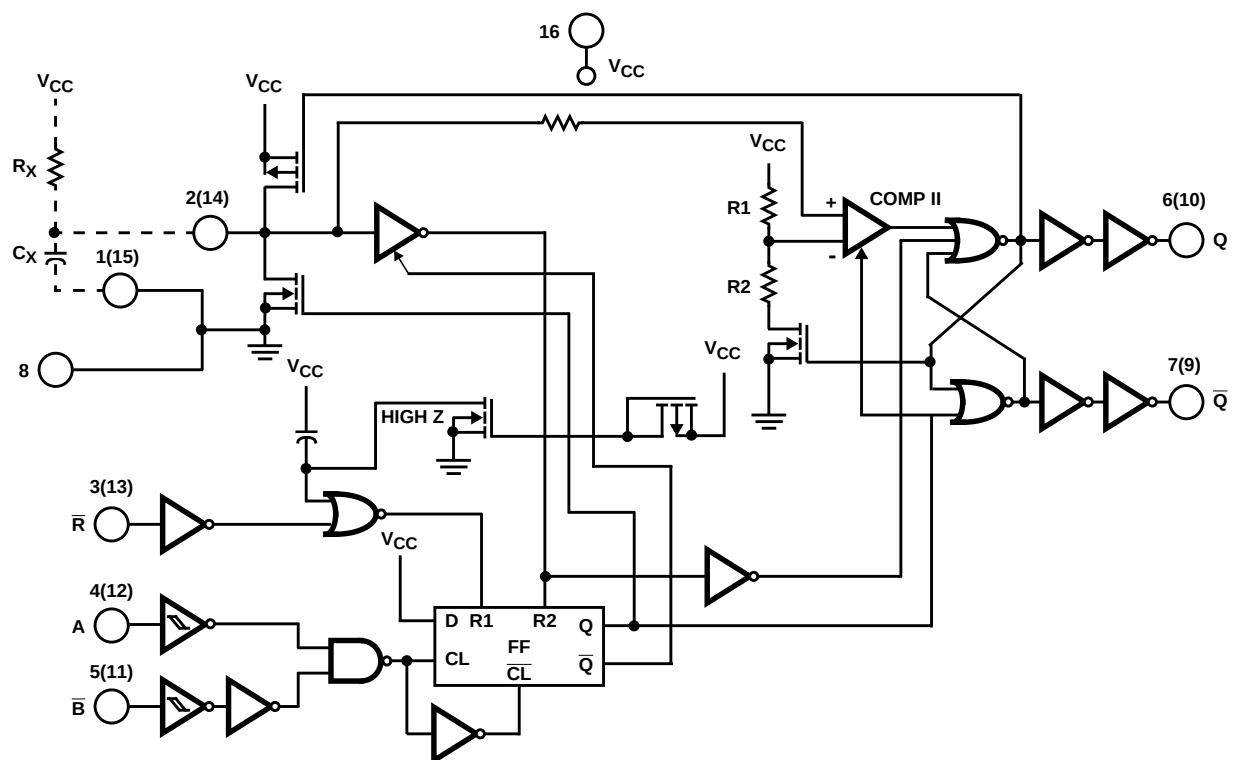


FIGURE 2. LOGIC DIAGRAM (1 MONO)

FUNCTIONAL TERMINAL CONNECTIONS

FUNCTION	V _{CC} TO TERMINAL NUMBER		GND TO TERMINAL NUMBER		INPUT PULSE TO TERMINAL NUMBER		OTHER CONNECTIONS	
	MONO ₁	MONO ₂	MONO ₁	MONO ₂	MONO ₁	MONO ₂	MONO ₁	MONO ₂
Leading-Edge Trigger/Retriggerable	3, 5	11, 13			4	12		
Leading-Edge Trigger/Non-Retriggerable	3	13			4	12	5-7	11-9
Trailing-Edge Trigger/Retriggerable	3	13	4	12	5	11		
Trailing-Edge Trigger/Non-Retriggerable	3	13			5	11	4-6	12-10

NOTES:

1. A retriggerable one-shot multivibrator has an output pulse width which is extended one full time period (T) after application of the last trigger pulse.
2. A non-triggerable one-shot multivibrator has a time period (T) referenced from the application of the first trigger pulse.



FIGURE 3. INPUT PULSE TRAIN

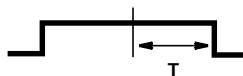


FIGURE 4. RETRIGGERABLE MODE
PULSE WIDTH (A MODE)



FIGURE 5. NON-RETRIGGERABLE MODE
PULSE WIDTH
(A MODE)

CD54HC4538, CD74HC4538, CD54HCT4538, CD74HCT4538

Absolute Maximum Ratings

DC Supply Voltage, V_{CC}	-0.5V to 7V
DC Input Diode Current, I_{IK}	
For $V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$	$\pm 20mA$
DC Output Diode Current, I_{OK}	
For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$	$\pm 20mA$
DC Output Source or Sink Current per Output Pin, I_O	
For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$	$\pm 25mA$
DC V_{CC} or Ground Current, I_{CC}	$\pm 50mA$

Operating Conditions

Temperature Range, T_A	-55°C to 125°C
Supply Voltage Range, V_{CC} (Note 3)	
HC Types	.2V to 6V
HCT Types	4.5V to 5.5V
DC Input or Output Voltage, V_I , V_O	0V to V_{CC}
Input Rise and Fall Times, t_r , t_f	
Reset Input:	
2V	1000ns (Max)
4.5V	500ns (Max)
6V	400ns (Max)
Trigger Inputs A or B:	
2V	Unlimited (Max)
4.5V	Unlimited (Max)
6V	Unlimited (Max)
External Timing Resistor, R_X (Note 4)	.5k Ω (Min)
External Timing Capacitor, C_X (Note 4)	0 (Min)

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTES:

- Unless otherwise specified, all voltages are referenced to ground.
- The maximum allowable values of R_X and C_X are a function of leakage of capacitor C_X , the leakage of the 'HC4538, and leakage due to board layout and surface resistance. Values of R_X and C_X should be chosen so that the maximum current into pin 2 or pin 14 is 30mA. Susceptibility to externally induced noise signals may occur for $R_X > 1M\Omega$.
- The package thermal impedance is calculated in accordance with JESD 51-7.

DC Electrical Specifications

PARAMETER	SYMBOL	TEST CONDITIONS		V _{CC} (V)	25°C			-40°C TO 85°C		-55°C TO 125°C		UNITS
		V _I (V)	I _O (mA)		MIN	TYP	MAX	MIN	MAX	MIN	MAX	
HC TYPES												
High Level Input Voltage	V _{IH}	-	-	2	1.5	-	-	1.5	-	1.5	-	V
				4.5	3.15	-	-	3.15	-	3.15	-	V
				6	4.2	-	-	4.2	-	4.2	-	V
Low Level Input Voltage	V _{IL}	-	-	2	-	-	0.5	-	0.5	-	0.5	V
				4.5	-	-	1.35	-	1.35	-	1.35	V
				6	-	-	1.8	-	1.8	-	1.8	V
High Level Output Voltage CMOS Loads	V _{OH}	V _{IH} or V _{IL}	-0.02	2	1.9	-	-	1.9	-	1.9	-	V
			-0.02	4.5	4.4	-	-	4.4	-	4.4	-	V
			-0.02	6	5.9	-	-	5.9	-	5.9	-	V
High Level Output Voltage TTL Loads			-	-	-	-	-	-	-	-	-	V
			-4	4.5	3.98	-	-	3.84	-	3.7	-	V
			-5.2	6	5.48	-	-	5.34	-	5.2	-	V

CD54HC4538, CD74HC4538, CD54HCT4538, CD74HCT4538

DC Electrical Specifications (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS		V _{CC} (V)	25°C			-40°C TO 85°C		-55°C TO 125°C		UNITS
		V _I (V)	I _O (mA)		MIN	TYP	MAX	MIN	MAX	MIN	MAX	
Low Level Output Voltage CMOS Loads	V _{OL}	V _{IH} or V _{IL}	0.02	2	-	-	0.1	-	0.1	-	0.1	V
			0.02	4.5	-	-	0.1	-	0.1	-	0.1	V
			0.02	6	-	-	0.1	-	0.1	-	0.1	V
Low Level Output Voltage TTL Loads			-	-	-	-	-	-	-	-	-	V
			4	4.5	-	-	0.26	-	0.33	-	0.4	V
			5.2	6	-	-	0.26	-	0.33	-	0.4	V
Input Leakage Current A, B, R	I _I	V _{CC} or GND	-	6	-	-	±0.1	-	±1	-	±1	μA
Input Leakage Current R _X C _X (Note 6)			-	6	-	-	±0.05	-	±0.5	-	±0.5	μA
Quiescent Device Current	I _{CC}	V _{CC} or GND	0	6	-	-	8	-	80	-	160	μA
Active Device Current Q = High & Pins 2, 14 at V _{CC} /4	I _{CC}	V _{CC} or GND	0	6	-	-	0.6	-	0.8	-	1	mA
HCT TYPES												
High Level Input Voltage	V _{IH}	-	-	4.5 to 5.5	2	-	-	2	-	2	-	V
Low Level Input Voltage	V _{IL}	-	-	4.5 to 5.5	-	-	0.8	-	0.8	-	0.8	V
High Level Output Voltage CMOS Loads	V _{OH}	V _{IH} or V _{IL}	-0.02	4.5	4.4	-	-	4.4	-	4.4	-	V
High Level Output Voltage TTL Loads			-4	4.5	3.98	-	-	3.84	-	3.7	-	V
Low Level Output Voltage CMOS Loads	V _{OL}	V _{IH} or V _{IL}	0.02	4.5	-	-	0.1	-	0.1	-	0.1	V
Low Level Output Voltage TTL Loads			4	4.5	-	-	0.26	-	0.33	-	0.4	V
Input Leakage Current	I _I	V _{CC} and GND	-	5.5	-	-	±0.1	-	±1	-	±1	μA
Input Leakage Current R _X C _X (Note 6)			-	5.5	-	-	±0.05	-	±0.5	-	±0.5	μA
Quiescent Device Current	I _{CC}	V _{CC} or GND	0	5.5	-	-	8	-	80	-	160	μA
Active Device Current Q = High & Pins 2, 14 at V _{CC} /4	I _{CC}	V _{CC} or GND	0	5.5	-	-	0.6	-	0.8	-	1	mA
Additional Quiescent Device Current Per Input Pin: 1 Unit Load	ΔI _{CC} (Note 7)	V _{CC} -2.1	-	4.5 to 5.5	-	100	360	-	450	-	490	μA

NOTES:

- When testing I_{IL} the Q output must be high. If Q is low (device not triggered) the pull-up P device will be ON and the low resistance path from V_{DD} to the test pin will cause a current far exceeding the specification.
- For dual-supply systems theoretical worst case (V_I = 2.4V, V_{CC} = 5.5V) specification is 1.8mA.

CD54HC4538, CD74HC4538, CD54HCT4538, CD74HCT4538

HCT Input Loading Table

INPUT	UNIT LOADS
All	0.5

NOTE: Unit Load is ΔI_{CC} limit specified in DC Electrical Table, e.g. 360 μ A max at 25°C.

Prerequisite for Switching Specifications

PARAMETER	SYMBOL	V _{CC} (V)	25°C			-40°C TO 85°C			-55°C TO 125°C			UNITS
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
HC TYPES												
Input Pulse Widths A, $\overline{B}$	t_{WH}, t_{WL}	2	80	-	-	100	-	-	120	-	-	ns
		4.5	16	-	-	20	-	-	24	-	-	ns
		6	14	-	-	17	-	-	20	-	-	ns
$\overline{R}$	t_{WL}	2	80	-	-	100	-	-	120	-	-	ns
		4.5	16	-	-	20	-	-	24	-	-	ns
		6	14	-	-	17	-	-	20	-	-	ns
Reset Recovery Time	t_{REC}	2	5	-	-	5	-	-	5	-	-	ns
		4.5	5	-	-	5	-	-	5	-	-	ns
		6	5	-	-	5	-	-	5	-	-	ns
Retrigger Time (Figure 11)	t_{rT}	5	-	175	-	-	-	-	-	-	-	ns
HCT TYPES												
Input Pulse Widths A, $\overline{B}$	t_{WH}, t_{WL}	4.5	16	-	-	20	-	-	24	-	-	ns
		$\overline{R}$	t_{WL}	4.5	20	-	-	25	-	-	30	-
Reset Recovery Time	t_{REC}	4.5	5	-	-	5	-	-	5	-	-	ns
Retrigger Time (Figure 11)	t_{rT}	5	-	175	-	-	-	-	-	-	-	ns

CD54HC4538, CD74HC4538, CD54HCT4538, CD74HCT4538

Switching Specifications $C_L = 50\text{pF}$, Input $t_r, t_f = 6\text{ns}$, $R_X = 10\text{k}\Omega$, $C_X = 0$

PARAMETER	SYMBOL	TEST CONDITIONS	V _{CC} (V)	25°C			-40°C TO 85°C		-55°C TO 125°C		UNITS
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
HC TYPES											
Propagation Delay A, $\overline{B}$ to Q	t _{PLH}	C _L = 50pF	2	-	-	250	-	315	-	375	ns
			4.5	-	-	50	-	63	-	75	ns
		C _L = 15pF	5	-	21	-	-	-	-	-	ns
		C _L = 50pF	6	-	-	43	-	54	-	64	ns
A, $\overline{B}$ to $\overline{Q}$	t _{PHL}	C _L = 50pF	2	-	-	250	-	315	-	375	ns
			4.5	-	-	50	-	63	-	75	ns
		C _L = 15pF	5	-	21	-	-	-	-	-	ns
		C _L = 50pF	6	-	-	43	-	54	-	64	ns
$\overline{R}$ to Q	t _{PHL}	C _L = 50pF	2	-	-	250	-	315	-	375	ns
			4.5	-	-	50	-	63	-	75	ns
		C _L = 15pF	5	-	21	-	-	-	-	-	ns
		C _L = 50pF	6	-	-	43	-	54	-	64	ns
$\overline{R}$ to $\overline{Q}$	t _{PLH}	C _L = 50pF	2	-	-	250	-	315	-	375	ns
			4.5	-	-	50	-	63	-	75	ns
		C _L = 15pF	5	-	21	-	-	-	-	-	ns
		C _L = 50pF	6	-	-	43	-	54	-	64	ns
Output Transition Time	t _{TLH} , t _{THL}	C _L = 50pF	2	-	-	75	-	95	-	110	ns
			4.5	-	-	15	-	19	-	22	ns
			6	-	-	13	-	16	-	19	ns
Output Pulse Width R _X = 10k, C _X = 0.1μF	τ	C _L = 50pF	3	0.64	-	0.78	0.612	0.812	0.605	0.819	ms
			5	0.63	-	0.77	0.602	0.798	0.595	0.805	ms
Output Pulse Width Match, Same Package	-	-		-	±1	-	-	-	-	-	%
Power Dissipation Capacitance (Notes 8, 9)	C _{PD}	C _L = 15pF	5	-	136	-	-	-	-	-	pF
Input Capacitance	C _I	C _L = 50pF	-	10	-	10	-	10	-	10	pF
HCT TYPES											
Propagation Delay A, $\overline{B}$ to Q	t _{PLH}	C _L = 50pF	4.5	-	-	55	-	69	-	83	ns
		C _L = 15pF	5	-	23	-	-	-	-	-	ns
A, $\overline{B}$ to $\overline{Q}$	t _{PHL}	C _L = 50pF	4.5	-	-	55	-	69	-	83	ns
		C _L = 15pF	5	-	23	-	-	-	-	-	ns

CD54HC4538, CD74HC4538, CD54HCT4538, CD74HCT4538

Switching Specifications $C_L = 50\text{pF}$, Input $t_r, t_f = 6\text{ns}$, $R_X = 10\text{K}\Omega$, $C_X = 0$ (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS	V_{CC} (V)	25°C			-40°C TO 85°C		-55°C TO 125°C		UNITS
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$\bar{R}$ to Q	t_{PHL}	$C_L = 50\text{pF}$	4.5	-	-	40	-	50	-	60	ns
		$C_L = 15\text{pF}$	5	-	17	-	-	-	-	-	ns
$\bar{R}$ to $\bar{Q}$	t_{PLH}	$C_L = 50\text{pF}$	4.5	-	-	50	-	63	-	75	ns
		$C_L = 15\text{pF}$	5	-	21	-	-	-	-	-	ns
Output Transition Time	t_{TLH}, t_{THL}	$C_L = 50\text{pF}$	4.5	-	-	15	-	19	-	22	ns
Output Pulse Width $R_X = 10\text{k}$, $C_X = 0.1\mu\text{F}$	τ	$C_L = 50\text{pF}$	5	0.63	-	0.77	0.602	0.798	0.595	0.805	ms
Output Pulse Width Match, Same Package	-	-	-	-	± 1	-	-	-	-	-	%
Power Dissipation Capacitance (Notes 8, 9)	C_{PD}	$C_L = 15\text{pF}$	5	-	134	-	-	-	-	-	pF
Input Capacitance	C_I	$C_L = 50\text{pF}$	-	10	-	10	-	10	-	10	pF

NOTES:

8. C_{PD} is used to determine the dynamic power consumption, per one shot.
9. $P_D = (C_{PD} + C_X) V_{CC}^2 f_i \sum (C_L V_{CC}^2 f_O)$ where f_i = input frequency, f_O = output frequency, C_L = output load capacitance, C_X = external capacitance V_{CC} = supply voltage assuming $f_i \ll \frac{1}{\tau}$

Test Circuits and Waveforms

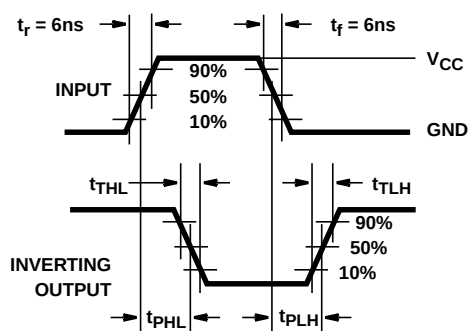


FIGURE 6. HC AND HCU TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

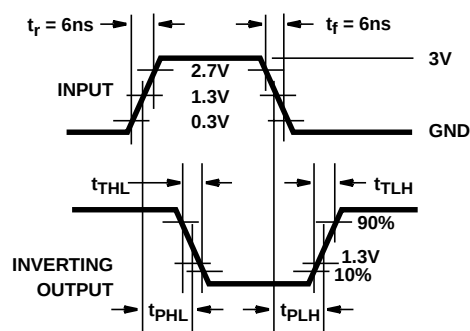


FIGURE 7. HCT TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

Typical Performance Curves

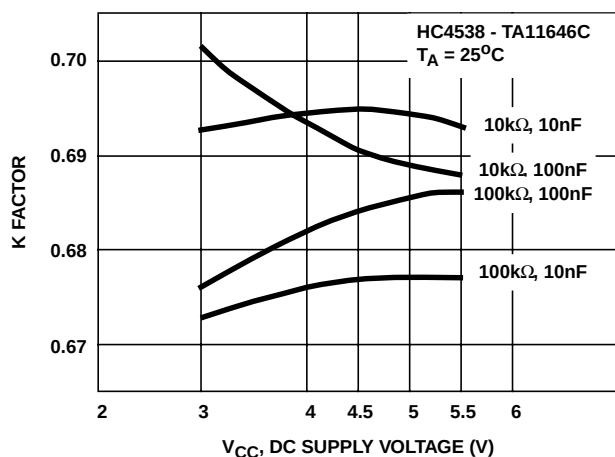


FIGURE 8. K FACTOR vs DC SUPPLY VOLTAGE (V_{CC}) - V

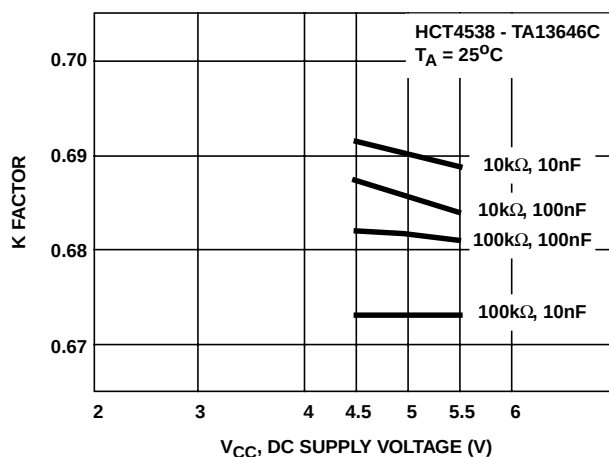


FIGURE 9. K FACTOR vs DC SUPPLY VOLTAGE (V_{CC}) - V

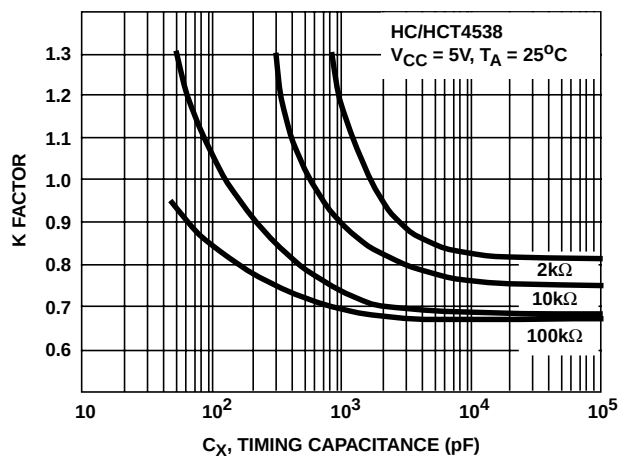


FIGURE 10. K FACTOR vs C_X

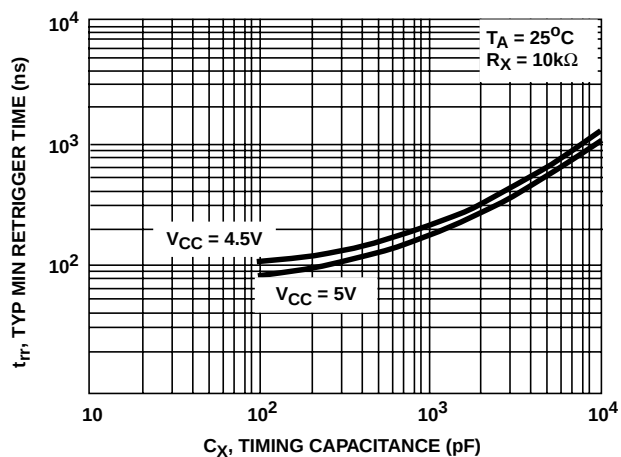


FIGURE 11. MINIMUM RETRIGGER TIME vs TIMING CAPACITANCE

Power-Down Mode

During a rapid power-down condition, as would occur with a power-supply short circuit with a poorly filtered power supply, the energy stored in C_X could discharge into Pin 2 or 14. To avoid possible device damage in this mode, when C_X is $\geq 0.5\mu\text{F}$, a protection diode with a 1 ampere or higher rating (1N5395 or equivalent) and a separate ground return for C_X should be provided as shown in Figure 12.

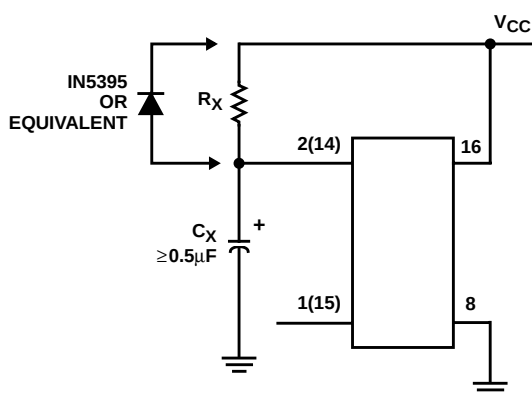


FIGURE 12. RAPID POWER-DOWN PROTECTION CIRCUIT

An alternate protection method is shown in Figure 13, where a 51Ω current-limiting resistor is inserted in series with C_X . Note that a small pulse width decrease will occur however, and R_X must be appropriately increased to obtain the originally desired pulse width.

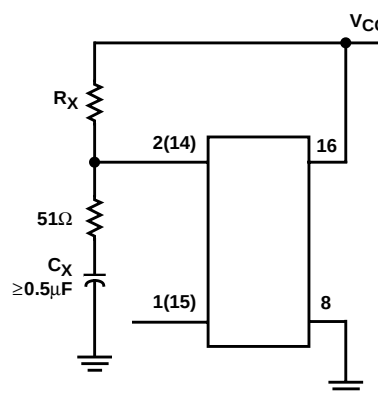
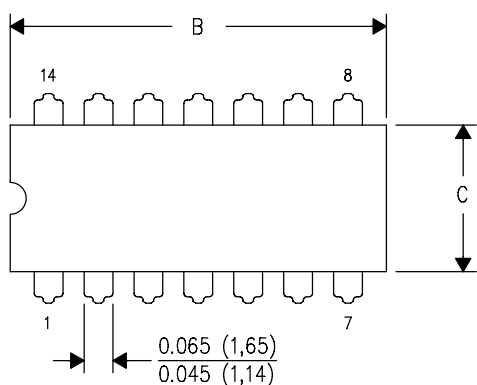


FIGURE 13. ALTERNATE RAPID POWER-DOWN PROTECTION CIRCUIT

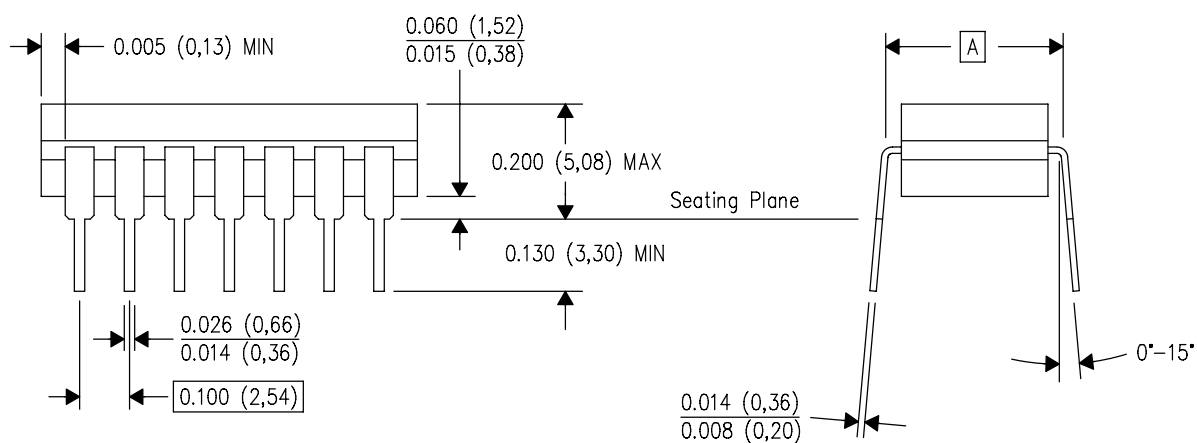
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



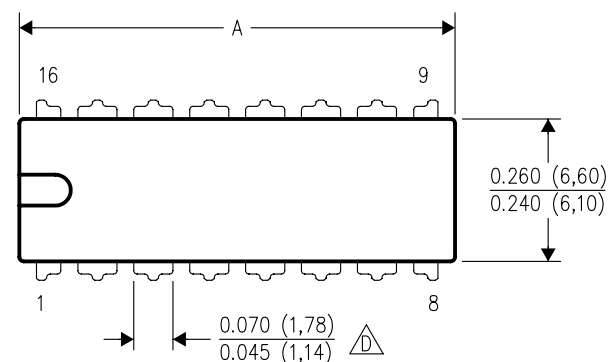
4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

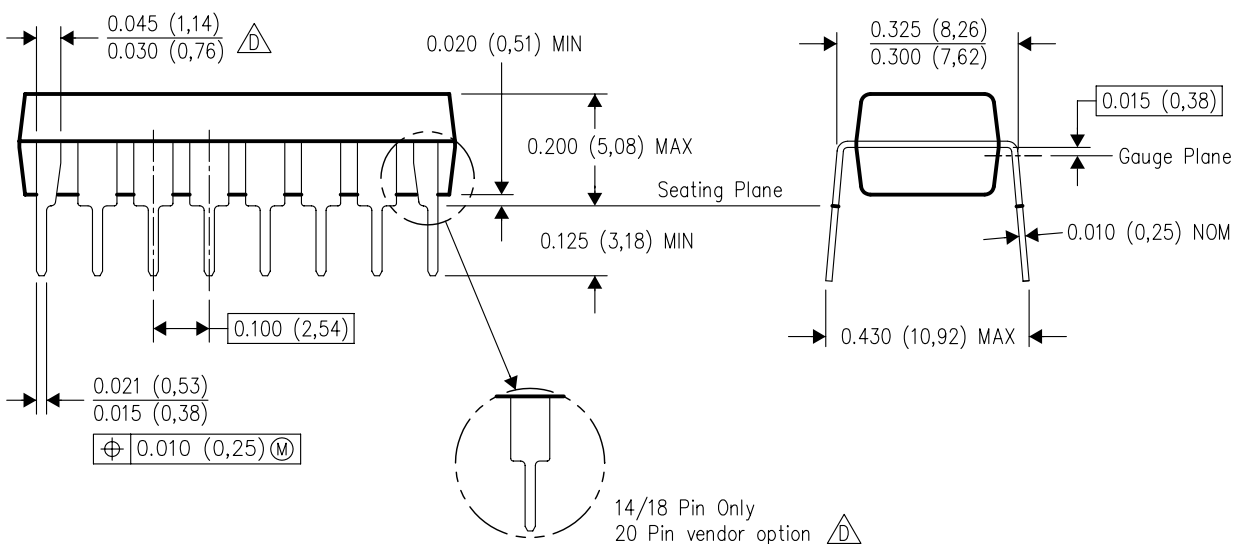
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD

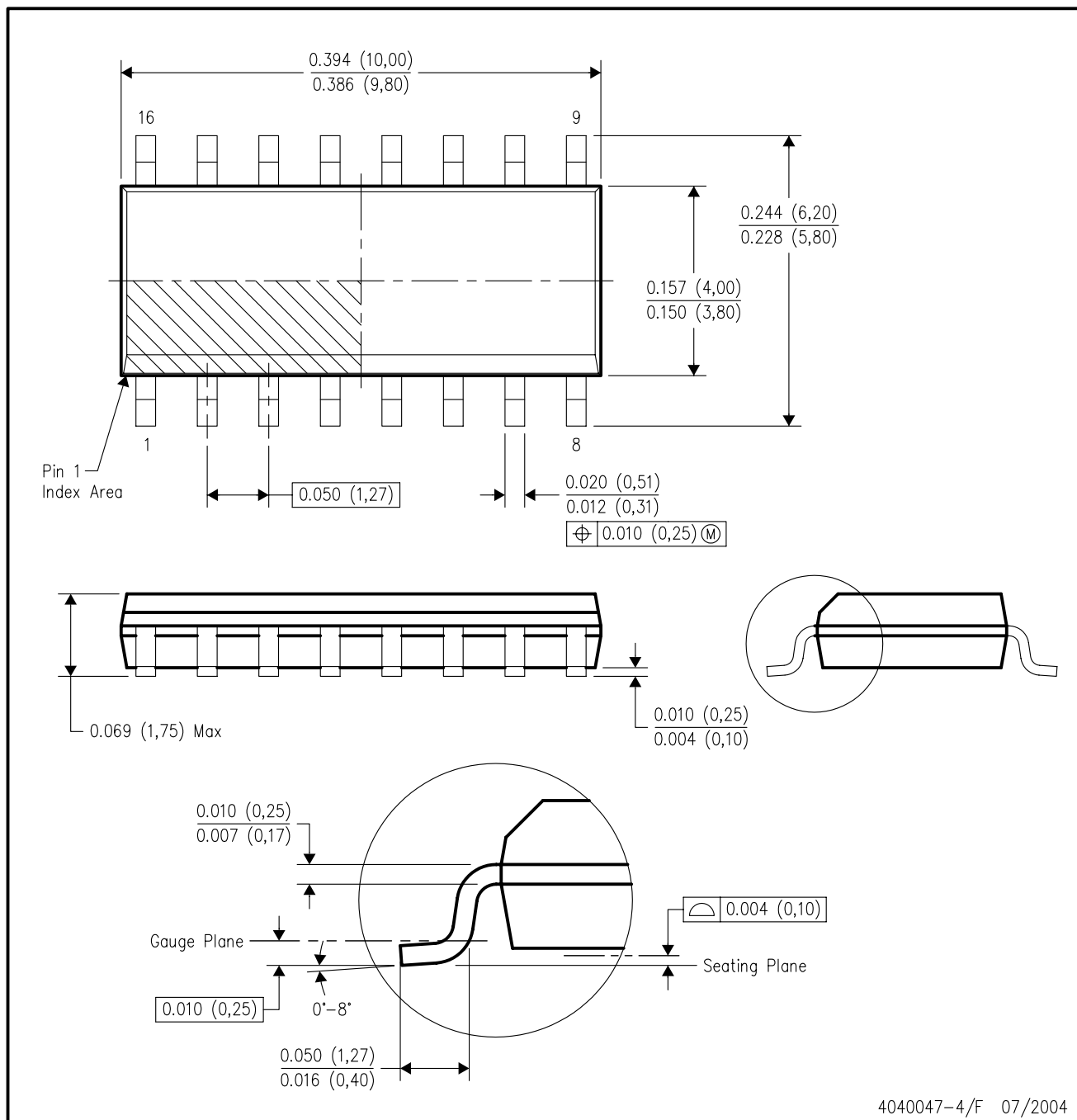


4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 -  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 -  The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



4040047-4/F 07/2004

NOTES:

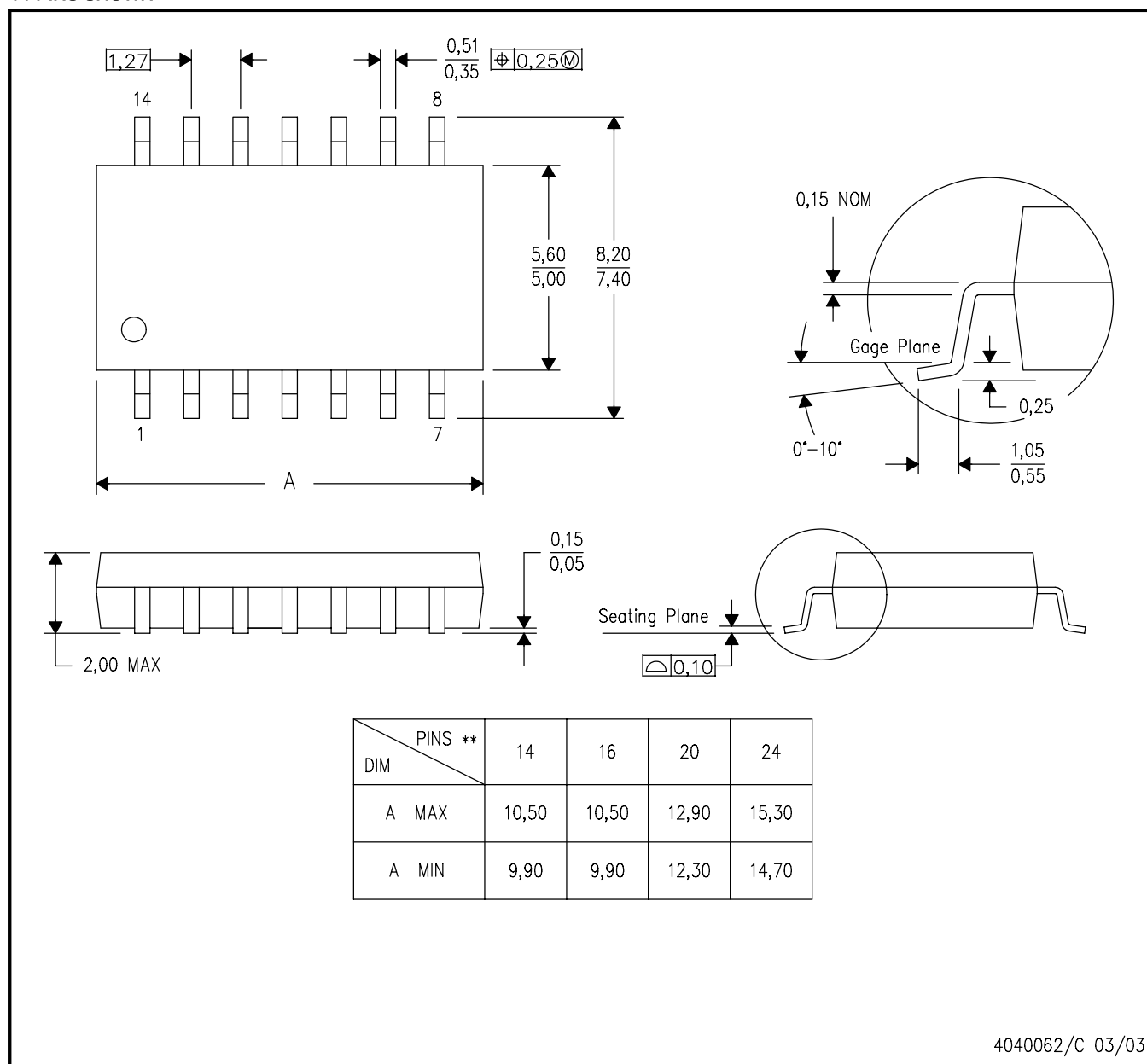
- All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- Falls within JEDEC MS-012 variation AC.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN

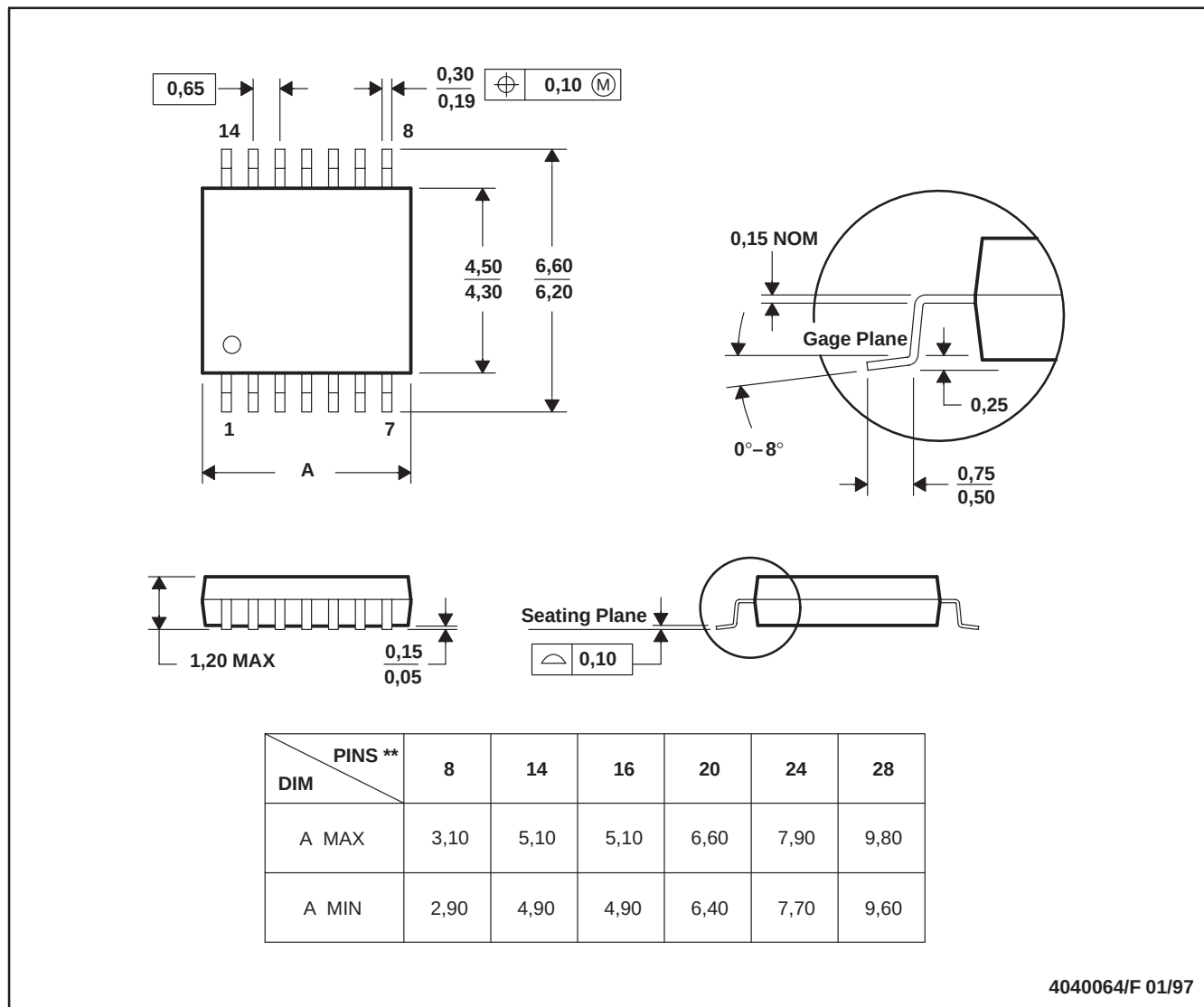


- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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